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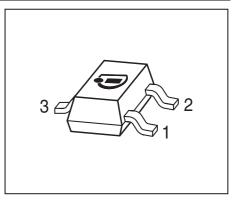


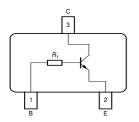


BCR519

NPN Silicon Digital Transistor

- Switching circuit, inverter circuit, driver circuit
- Built in bias resistor (R_1 = 4.7 k Ω)





Туре	Marking	Pin Configuration			Package
BCR519	XKs	1=B	2=E	3=C	SOT23

Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V _{CEO}	50	V	
Collector-base voltage	V _{CBO}	50		
Input forward voltage	V _{i(fwd)}	30		
Input reverse voltage	V _{i(rev)}	5		
Collector current	I _C	500	mA	
Total power dissipation-	P _{tot}	330	mW	
<i>T</i> _S ≤ 79 °C				
Junction temperature	T _i	150	°C	
Storage temperature	T _{stg}	-65 150		
Thermal Resistance			•	

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	≤ 215	K/W

¹For calculation of $R_{\rm thJA}$ please refer to Application Note Thermal Resistance



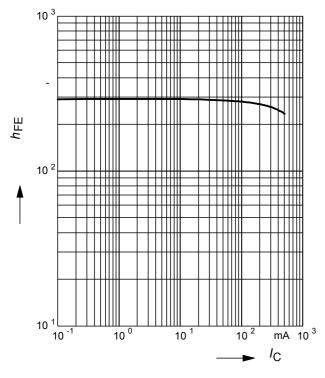
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					1
Collector-emitter breakdown voltage	V _{(BR)CEO}	50	-	-	V
$I_{\rm C} = 100 \ \mu {\rm A}, \ I_{\rm B} = 0$					
Collector-base breakdown voltage	V _{(BR)CBO}	50	-	-	
/ _C = 10 μA, / _E = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 50 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	/ _{EBO}	-	-	100	nA
$V_{\rm EB} = 5 \rm V, I_{\rm C} = 0$					
DC current gain-	h _{FE}	120	-	630	-
<i>I</i> _C = 50 mA, <i>V</i> _{CE} = 5 V					
Collector-emitter saturation voltage ¹⁾	V _{CEsat}	-	-	0.3	V
<i>I</i> _C = 50 mA, <i>I</i> _B = 2.5 mA					
Input off voltage	V _{i(off)}	0.4	-	0.8]
<i>I</i> _C = 100 μA, <i>V</i> _{CE} = 5 V					
Input on voltage	V _{i(on)}	0.5	-	1.5	
<i>I</i> _C = 10 mA, <i>V</i> _{CE} = 0.3 V					
Input resistor	R ₁	3.2	4.7	6.2	kΩ
AC Characteristics					
Transition frequency	f _T	-	100	-	MHz
<i>I</i> _C = 50 mA, <i>V</i> _{CE} = 5 V, <i>f</i> = 100 MHz					

Electrical Characteristics	at T	$= 25^{\circ}$ C	unless	otherwise	snecified
	αι //		่นเมธุรร		specified

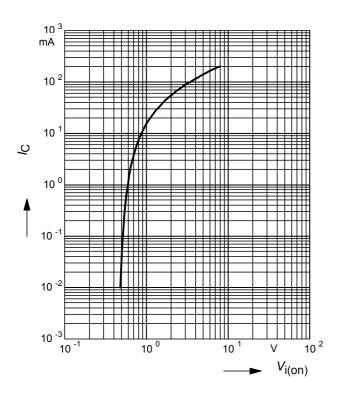
¹Pulse test: t < 300 μ s; D < 2%



DC current gain $h_{\text{FE}} = f(l_{\text{C}})$ $V_{\text{CE}} = 5 \text{ V}$ (common emitter configuration)

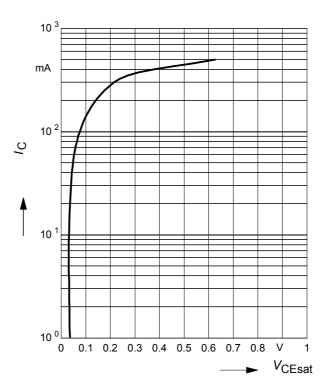


Input on Voltage $V_{i(on)} = f(I_C)$ $V_{CE} = 0.3V$ (common emitter configuration)

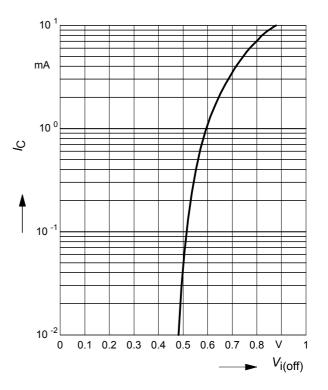


Collector-emitter saturation voltage

 $V_{\text{CEsat}} = f(I_{\text{C}}), h_{\text{FE}} = 20$



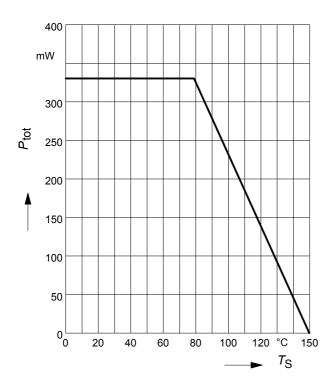
Input off voltage $V_{i(off)} = f(I_C)$ $V_{CE} = 5V$ (common emitter configuration)





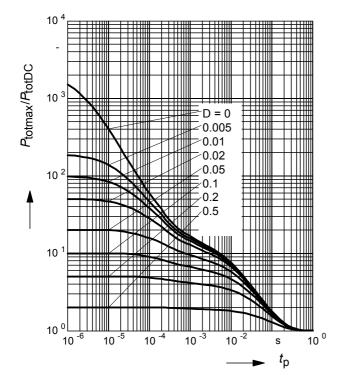
Total power dissipation $P_{tot} = f(T_S)$

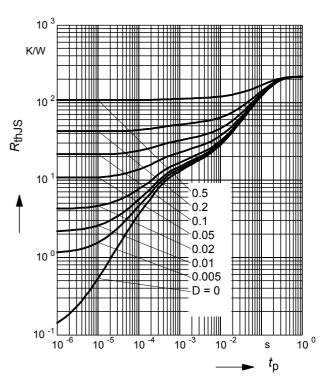
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



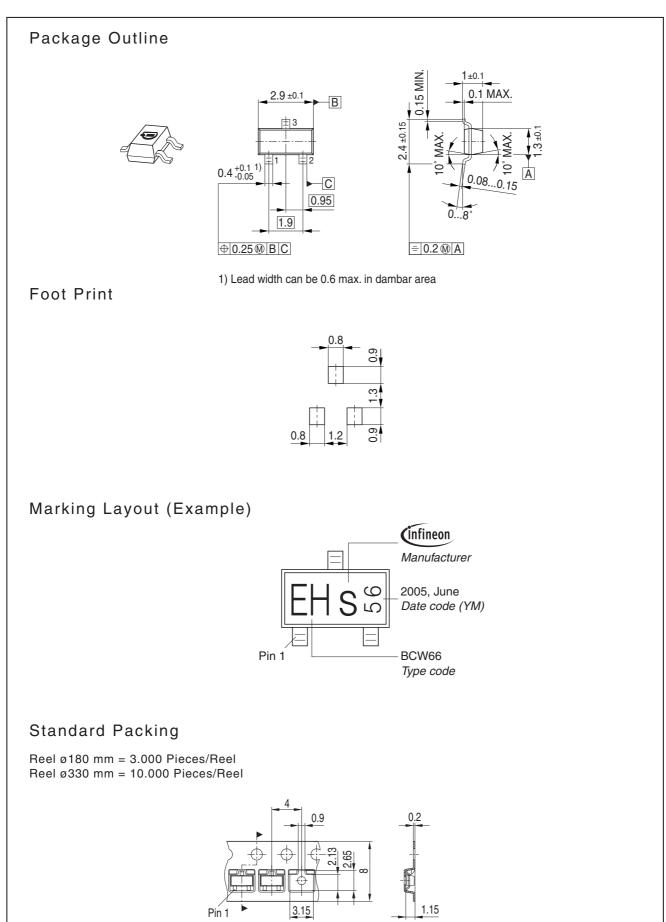
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$











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